

Eaton 218261

Eaton Moeller® series M22 Button plate, mushroom black, arrow symbol M22-XDP-S-X7

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PRODUCT NAME	Eaton Moeller® series M22 Accessory Button plate
CATALOG NUMBER	218261
PRODUCT LENGTH/DEPTH	24 mm
PRODUCT HEIGHT	9 mm
PRODUCT WIDTH	24 mm
PRODUCT WEIGHT	0.002 kg
CERTIFICATIONS	UL/CSA certification not required



USED WITH	M22(S)-D(R)P
PRODUCT CATEGORY	Accessories
10.10 TEMPERATURE RISE	Not applicable.
10.11 SHORT-CIRCUIT RATING	Is the panel builder's responsibility. The specifications for the switchgear must be observed.
10.12 ELECTROMAGNETIC COMPATIBILITY	Is the panel builder's responsibility. The specifications for the switchgear must be observed.
10.13 MECHANICAL FUNCTION	The device meets the requirements, provided the information in the instruction leaflet (IL) is observed.
10.2.2 CORROSION RESISTANCE	Meets the product standard's requirements.
10.2.3.1 VERIFICATION OF THERMAL STABILITY OF ENCLOSURES	Meets the product standard's requirements.
10.2.3.2 VERIFICATION OF RESISTANCE OF INSULATING MATERIALS TO NORMAL HEAT	Meets the product standard's requirements.
10.2.3.3 RESIST. OF INSUL. MAT. TO ABNORMAL HEAT/FIRE BY INTERNAL ELECT. EFFECTS	Meets the product standard's requirements.
10.2.4 RESISTANCE TO ULTRA-VIOLET (UV) RADIATION	Please enquire
10.2.5 LIFTING	Does not apply, since the entire switchgear needs to be evaluated.
10.2.6 MECHANICAL IMPACT	Does not apply, since the entire switchgear needs to be evaluated.
10.2.7 INSCRIPTIONS	Meets the product standard's requirements.
10.3 DEGREE OF PROTECTION OF ASSEMBLIES	Does not apply, since the entire switchgear needs to be evaluated.
10.4 CLEARANCES AND CREEPAGE DISTANCES	Meets the product standard's requirements.
10.5 PROTECTION AGAINST ELECTRIC	Does not apply, since the entire switchgear needs to

be evaluated.

SHOCK

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00/00	RMQ small E-Stop emergency-stop button

10.6 INCORPORATION OF SWITCHING DEVICES AND COMPONENTS Does not apply, since the entire switchgear needs to be evaluated. 10.7 INTERNAL ELECTRICAL CIRCUITS AND CONNECTIONS Is the panel builder's responsibility. 10.8 CONNECTIONS FOR EXTERNAL CONDUCTORS Is the panel builder's responsibility. 10.9.2 POWER-FREQUENCY ELECTRIC STRENGTH Is the panel builder's responsibility. 10.9.3 IMPULSE WITHSTAND VOLTAGE Is the panel builder's responsibility. 10.9.4 TESTING OF ENCLOSURES MADE OF INSULATING MATERIAL Is the panel builder's responsibility. CONSTRUCTION TYPE Flat CONNECTION TO SMARTWIRE-DT No AMBIENT OPERATING TEMPERATURE - MAX 70 °C AMBIENT OPERATING TEMPERATURE - MAX 0 W EQUIPMENT HEAT DISSIPATION, CURRENT-DEPENDENT PVID 0 W HEAT DISSIPATION PER POLE, CURRENT-DEPENDENT PVID 0 W OUTSIDE DIAMETER 22.5 mm RATED OPERATIONAL CURRENT-FOR SPECIFIED HEAT DISSIPATION, NON-CURRENT-PORSPECIFIED HEAT DISSIPATION (IN) 0 A STATIC HEAT DISSIPATION (IN) 0 W STATIC HEAT DISSIPATION (IN) 0 W COLOR Black SHAPE Round LANGUAGE Other		
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PROJECT NAME:	
PROJECT NUMBER:	
PREPARED BY:	
ПП:	



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